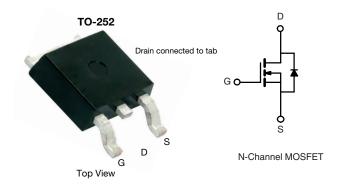


www.vishay.com Vishay Siliconix

Automotive N-Channel 300 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	300			
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.330			
I _D (A)	10			
Configuration	Single			



FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- AEC-Q101 qualified d
- 100 % R_a tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



ORDERING INFORMATION			
Package	TO-252		
Lead (Pb)-free and Halogen-free	SQD10N30-330H-GE3		

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	Drain-Source Voltage			V	
Gate-Source Voltage	V_{GS}	± 30	V		
Continuous Drain Current	T _C = 25 °C	I-	10	A	
Continuous Diam Current	T _C = 125 °C	I _D	5		
Continuous Source Current (Diode Conduction) a		I _S	50		
Pulsed Drain Current ^b	I _{DM}	16			
Single Pulse Avalanche Current ^e	L = 0.05 mH	I _{AS}	12.65		
Single Pulse Avalanche Energy ^e	L = 0.03 IIIA	E _{AS}	4	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	Б	107	W	
iviaxiiiluiii Fowei Dissipatioii	T _C = 125 °C	P_{D}	35	VV	
Operating Junction and Storage Temperature Range)	T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-Ambient F	PCB Mount c	R_{thJA}	50	°C/W		
Junction-to-Case (Drain)		R _{thJC}	1.4	C/VV		

Notes

- a. Package limited.
- b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- c. When mounted on 1" square PCB (FR4 material).
- d. Parametric verification ongoing.
- e. $1.5 \text{ k}\Omega$ resistance in series with the gate.



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static		•						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	300	-	-	V	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	3.4	3.8	4.4	V	
Gate-Source Leakage	I _{GSS}	V _{DS} =	0 V, V _{GS} = ± 30 V	-	-	± 100	nA	
		V _{GS} = 0 V	V _{DS} = 300 V	-	-	1	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = 300 V, T _J = 125 °C	-	-	50	μΑ	
		$V_{GS} = 0 V$	$V_{DS} = 300 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$	-	-	250		
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	10	-	-	Α	
		V _{GS} = 10 V	I _D = 14 A	-	0.275	0.330	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 14 A, T _J = 125 °C	-	-	0.733		
		V _{GS} = 10 V	I _D = 14 A, T _J = 175 °C	-	-	1.000		
Forward Transconductance b	Forward Transconductance $^{\rm b}$ $g_{\rm fs}$ $V_{\rm DS}$ = 15 V, $I_{\rm D}$ = 14 A				26	-	S	
Dynamic ^b								
Input Capacitance	C _{iss}			-	1749	2190		
Output Capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = 25 V, f = 1 MHz	-	112	140	pF	
Reverse Transfer Capacitance	C _{rss}			-	44	55		
Total Gate Charge ^c	Qg			-	31	47		
Gate-Source Charge ^c	Q _{gs}	V _{GS} = 10 V	$V_{DS} = 150 \text{ V}, I_D = 7 \text{ A}$	-	8	-	nC	
Gate-Drain Charge ^c	Q _{gd}			-	9.6	-		
Gate Resistance	R _g	f = 1 MHz		0.4	0.8	3	Ω	
Turn-On Delay Time ^c	t _{d(on)}				10	15		
Rise Time ^c	t _r	V_{DD} = 150 V, R_L = 21 Ω $I_D \cong 7$ A, V_{GEN} = 10 V, R_g = 1 Ω		-	18	28	- ns	
Turn-Off Delay Time ^c	t _{d(off)}			-	20	30		
Fall Time ^c	t _f			-	8	12		
Source-Drain Diode Ratings and Characteristics b								
Source-Drain Diode Ratings and Chara-	cteristics b							
Source-Drain Diode Ratings and Charac Pulsed Current ^a	I _{SM}			-	-	16	А	

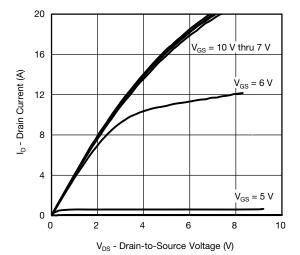
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

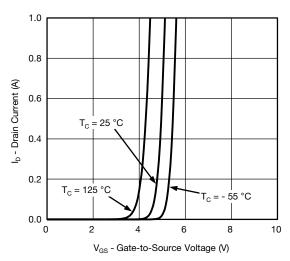
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



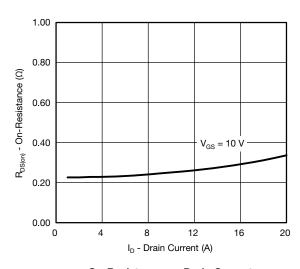
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



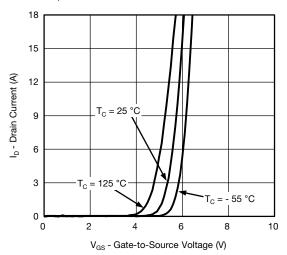
Output Characteristics



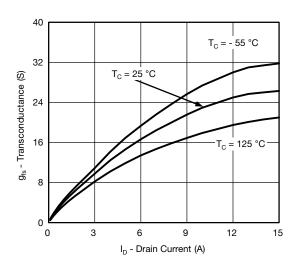
Transfer Characteristics



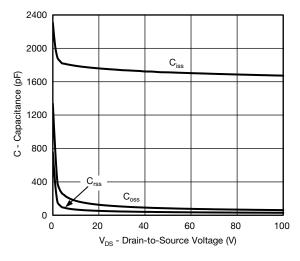
On-Resistance vs. Drain Current



Transfer Characteristics

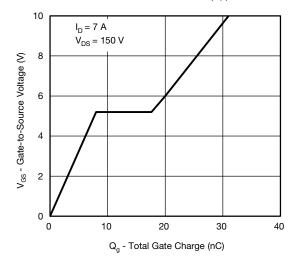


Transconductance

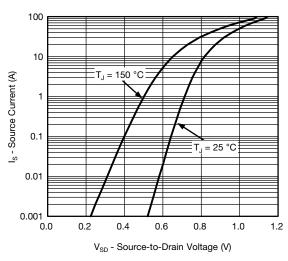




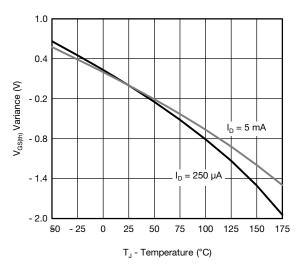
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



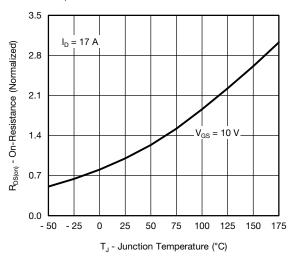
Gate Charge



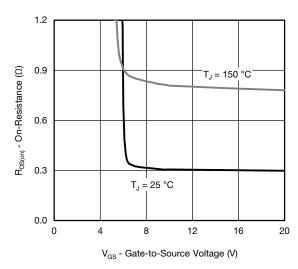
Source Drain Diode Forward Voltage



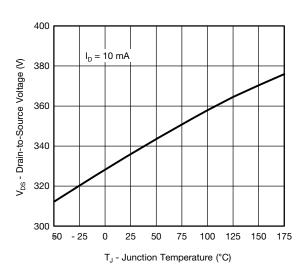
Threshold Voltage



On-Resistance vs. Junction Temperature



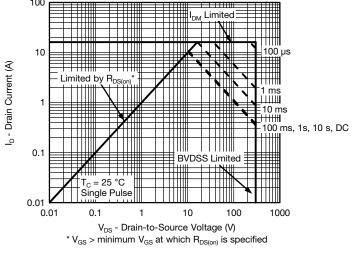
On-Resistance vs. Gate-to-Source Voltage



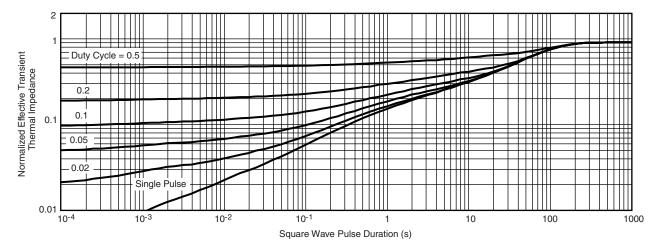
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



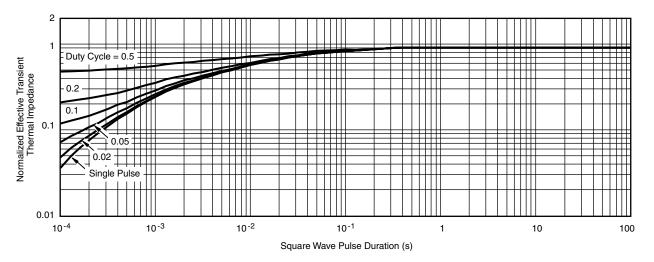
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg267070.



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REVISION HISTORY ^a					
REVISION	DATE	DESCRIPTION OF CHANGE			
В	26-Feb-2015	UIS changed			
С	04-May-2015	R _g , C _{iss} and t _r updated			

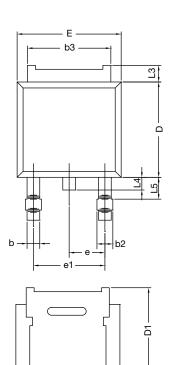
Note

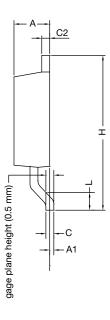
a. As of April 2014





TO-252AA Case Outline





	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56	BSC	0.180	BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T13-0592-Rev. A, 02-Sep-13					

DWG: 6019

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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